

High Tg Series

TRADE NAME	EPOXY EQUIVALENCY (g/eq)	VISCOSITY (mPa.s/25°C)	NON VOLATILITY (wt%)	BROMINE CONTENT (wt%)	CHARACTERSTICS
GEBR555K75	340-400	1000MAX	74-76	18-21	Tg150°C resin, for Lead free process CCL
GEBR558K75	280-320	200-1500	74-76	18-21	Tg170°C resin, suitable for high Tg CCL, lead free process, suitable for PN and DICY systems
GEBR558MK75	270-300	200-1500	74-76	18-21	Tg180°C resin , suitable for high Tg CCL, lead free process, suitable for PN system